

### **Powering Communications and Technology**

# IES020ZG

### **FEATURES**

- 20W Standard Package
- 88% Efficiency at 5VWide Range Input
- 100°C Case Operation
  3.3V Output Available
- Open Frame or Encapsulated
- 1500V Isolation
- Short Circuit
   Protection

### **TECHNICAL SPECIFICATIONS**

In	put
Voltage Range 24 VDC Nominal 48 VDC Nominal Input Undervoltage Lockout UVLO Hysteresis	16 - 36 VDC 36 - 72 VDC <34V or <17V 1V Nom.
Reflected Ripple Input Reverse Voltage Protection	25 mA Shunt Diode
Ou	tput
Setpoint Accuracy Line Regulation V <sub>in</sub> Min V <sub>in</sub> Max., I <sub>c</sub> Load Regulation I <sub>out</sub> Min I <sub>out</sub> Max., Minimum Output Current Dynamic Regulation, Loadstep Pk Deviation Settling Time Voltage Trim Range Short Circuit / Overcurrent Protection Current Limit Threshold Range, % of I OVP Trip Range OVP Type	V <sub>in</sub> Nom. 0.5% V <sub>ou</sub> 10 % 25% I <sub>ou</sub> 4% V <sub>ou</sub> 500 μs ±10% Shutdown / Hiccup

General Turn-On Time 10 ms Positive Logic Remote Shutdown Switching Frequency 300 kHz Open Frame / 450 kHz Cased Isolation 1500 VDC Input - Output Input - Case (24 Vin Units) 500 VDC Output - Case (48 Vin Units) 500 VDC Temperature Coefficient 0.03%/°C Case Temperature -40 To +100°C **Operating Range** Storage Range -40 To +125°C Humidity Max., Non-Condensing 95% Vibration, 3 Axes, 5 Min Each 5 g, 10 - 55 Hz 1.9 x 10<sup>6</sup> hrs MTBF<sup>†</sup> (Bellcore TR-NWT-000332) UL, CSA, EN60950 Safety Weight (approx.) 1.2 oz

# IES SERIES 20 WATT

### DESCRIPTION

IES DC/DC converters provide up to 20 Watts of output power in an industry standard package. With 88% efficiency and a maximum case temperature of 100°C, the IES is well suited for the most demanding telecom, networking, and industrial applications. The IES features 1500 VDC isolation, short circuit, and overtemperature protection.





#### Notes

<sup>†</sup> MTBF predictions may vary slightly from model to model.

Specifications typically at  $25^{\circ}$ C, normal line, and full load, unless otherwise stated.

Soldering Conditions: I/O pins, 260°C, ten seconds; fully compatible with commercial wave-soldering equipment.

Safety: Agency approvals may vary from model to model. Please consult factory for specific model information.

Units are water-washable and fully compatible with commercial spray or immersion post wave-solder washing equipment.

# **OUDER-ONE**

# **IES SERIES 20 WATT**

### **Powering Communications and Technology**

### **MODELS** - (See the last page of Section for options.)

Selection Chart							
Model	Vin (Volts)	Vin Range (Volts)	lin Max.* (Amps)	Vout (Volts)	lout Rated (Amps)	Ripple & Noise Pk-Pk (mV)	Efficiency Typ. **
IES020YG-A	24	16 - 36	1.23	5.0	4.0	75	87%
IES013ZE-A	48	36 - 72	0.45	3.3	4.0	150	83%
IES020ZG-A	48	36 - 72	0.65	5.0	4.0	75	87%

\* Maximum input current at minimum input voltage, maximum rated output power.

\*\* At nominal Vin, rated output.

### **MECHANICAL DRAWING**



0.18" (4.8mm) DIA 0.040\* (1.0mm) 0.40\* (10.2mm) **OPEN FRAME** 

Thermal Impedance				
Natural Convection 100 LFM 200 LFM 300 LFM 400 LFM	Encapsulated Modules 15.4 °C/W 12.2 °C/W 9.3 °C/W 7.4 °C/W 6.4 °C/W	Open Frame Modules 14.9 °C/W 11.3 °C/W 8.3 °C/W 6.8 °C/W 5.4 °C/W		
Note: Thermal impedance data is dependent on many environmental factors. The exact thermal performance should be validated for specific application.				

Function		
+V <sub>in</sub>		
-V <sub>in</sub>		
No Pin		
Shutdown		
+V <sub>out</sub>		
-Vout		
Trim		
No Pin		
No Pin		

Tolerances				
Inches: .XX ± 0.020 .XXX ± 0.010	(Millimeters) .X ± 0.5 .XX ± 0.25			
Pin: ± 0.002	± 0.05			
Case: + 0.04, - 0.00	+ 1.0, - 0.00			
(Dimensions as listed unless otherwise specified.)				

### **OPTIONS**



### **Powering Communications and Technology**

When ordering equipment options, use the following suffix information. Select the option(s) that you prefer and add them to the model number. Example ordering options are located below the options table.

OPTIONS	SUFFIX	APPLICABLE SERIES	REMARKS
Negative Logic	Ν	HAS, HBD, HBS, HES, HLS, LES,	TTL "Low" Turns Module ON
		QBS, QES, QLS, TES, TQD	TTL "High" Turns Module OFF
		HAS, HBD, HBS, HES, HLS, QBS, QES,	
Lucent Compatible Trim	Т	QLS	
Terminal Strip	TS	XWS, XWD, XWT	
Trim	1	IAS, LES	
Enable	2	IAD, IAS, LES, SMS	
Trim and Enable	3	IAS, LES	
Current Share	4	SMS	
Headerless	Y	Encapsulated EWS, IWS, OWS	
PIN LENGTH AND HEATSINK OPTIONS			Standard Pin Length is 0.180" (4.6mm)
0.110" (2.8mm) Pin Length	8	All Units (Except SMS)	
0.150" (3.8mm) Pin Length	9	All Units (Except SMS)	
0.24" (6.1mm) Horizontal Heatsink	1H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.24" (6.1mm) Vertical Heatsink	1V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.45" (11.4mm) Horizontal Heatsink	2H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.45" (11.4mm) Vertical Heatsink	2V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.95" (24.1mm) Horizontal Heatsink	3H	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad
0.95" (24.1mm) Vertical Heatsink	3V	All Units (Except DIP, HLS, HLD, QLS, SIP, SM TLD, and TKD Packages)	Includes Thermal Pad

Example Options:

HBS050ZG-ANT3V = HBS050ZG-A with negative logic, Lucent compatible trim, and 0.95" vertical heatsink. LES015YJ-3N = LES015YJ with optional trim and enable, negative logic. QBS066ZG-AT8 = QBS066ZG-A with Lucent compatible trim and 0.110" pin length.

NUCLEAR AND MEDICAL APPLICATIONS - Power-One products are not authorized for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems without the express written consent of the President of Power-One, Inc.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.